


SMA6L Series



Agency Approvals

| AGENCY | AGENCY FILE NUMBER |
|---|--------------------|
|  | E230531 |

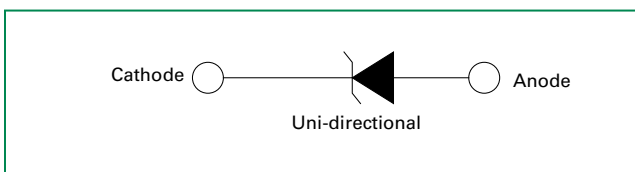
Maximum Ratings and Thermal Characteristics (T_A = 25°C unless otherwise noted)

| Parameter | Symbol | Value | Unit |
|---|------------------|------------|------|
| Peak Pulse Power Dissipation at T _A = 25°C by 10/1000µs Waveform (Fig.2)(Note 1), (Note 2) | P _{PPM} | 600 | W |
| Power Dissipation on Infinite Heat Sink at T _L = 50°C | P _D | 3 | W |
| Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3) | I _{FSM} | 60 | A |
| Maximum Instantaneous Forward Voltage at 25A for Unidirectional Only | V _F | 3.5 | V |
| Operating Temperature Range | T _J | -65 to 150 | °C |
| Storage Temperature Range | T _{STG} | -65 to 175 | °C |
| Typical Thermal Resistance Junction to Lead | R _{θJL} | 35 | °C/W |
| Typical Thermal Resistance Junction to Ambient | R _{θJA} | 200 | °C/W |

Notes:

1. Non-repetitive current pulse, per Fig.4 and derated above T_J (initial) = 25°C per Fig. 3.
2. Mounted on 5.0x5.0mm copper pad to each terminal.
3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional device only.

Functional Diagram



Description

The SMA6L series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

SMA low profile package has the same electrical performance as the SMB package but with lowest height profiles (1.1mm) in the industry.

Features

- Same power as standard SMB devices (600 W)
- SMA low profile package: less than 1.1 mm
- Footprint compatibility with standard SMA and SMB products (easy to layout)
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 30kV(Air), 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2
- EFT protection of data lines in accordance with IEC 61000-4-4
- Low inductance, excellent clamping capability
- Fast response time: typically less than 1.0ns from 0 Volts to V_{BR min}
- Built-in strain relief
- Glass passivated junction
- Typical I_R less than 1µA when V_{BR min} > 12V
- High temperature to reflow soldering guaranteed: 260°C/40sec
- V_{BR @ T_J} = V_{BR @ 25°C} × (1 + α T × (T_J - 25)) (α T: Temperature Coefficient, typical value is 0.1%)
- Plastic package is flammability rated V-0 per Underwriters Laboratories
- Meet MSL level1, per J-STD-020, LF maximum peak of 260°C
- Matte tin lead-free plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

Applications

TVS devices are ideal for the protection of I/O Interfaces, V_{CC} bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

Additional Information



Datasheet




Resources

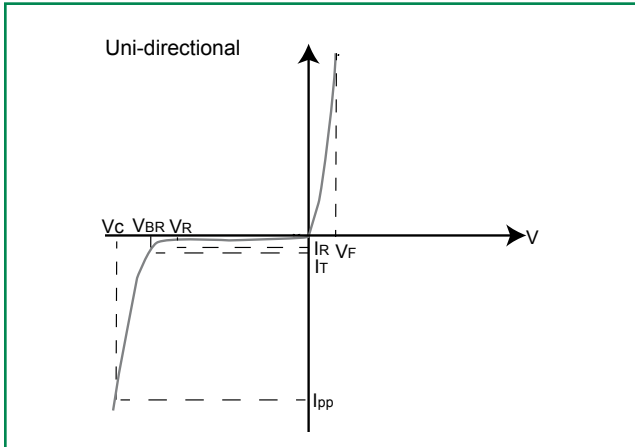


Samples

Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

| Part Number (Uni) | Marking Code | Reverse Stand off Voltage V_R (Volts) | Breakdown Voltage V_{BR} (Volts) @ I_T | | Test Current I_T (mA) | Maximum Clamping Voltage V_C @ I_{PP} (V) | Maximum Peak Pulse Current I_{PP} (A) | Maximum Reverse Leakage I_R @ V_R (μA) | Agency Approval  |
|-------------------|--------------|---|--|--------|-------------------------|---|---|---|---|
| | | | MIN | MAX | | | | | |
| SMA6L5.0A | AE | 5.0 | 6.40 | 7.00 | 10 | 9.2 | 65.3 | 800 | X |
| SMA6L6.0A | AG | 6.0 | 6.67 | 7.37 | 10 | 10.3 | 58.3 | 800 | X |
| SMA6L6.5A | AK | 6.5 | 7.22 | 7.98 | 10 | 11.2 | 53.6 | 500 | X |
| SMA6L7.0A | AM | 7.0 | 7.78 | 8.60 | 10 | 12.0 | 50.0 | 200 | X |
| SMA6L7.5A | AP | 7.5 | 8.33 | 9.21 | 1 | 12.9 | 46.6 | 100 | X |
| SMA6L8.0A | AR | 8.0 | 8.89 | 9.83 | 1 | 13.6 | 44.2 | 50 | X |
| SMA6L8.5A | AT | 8.5 | 9.44 | 10.40 | 1 | 14.4 | 41.7 | 20 | X |
| SMA6L9.0A | AV | 9.0 | 10.00 | 11.10 | 1 | 15.4 | 39.0 | 10 | X |
| SMA6L10A | AX | 10.0 | 11.10 | 12.30 | 1 | 17.0 | 35.3 | 5 | X |
| SMA6L11A | AZ | 11.0 | 12.20 | 13.50 | 1 | 18.2 | 33.0 | 1 | X |
| SMA6L12A | BE | 12.0 | 13.30 | 14.70 | 1 | 19.9 | 30.2 | 1 | X |
| SMA6L13A | BG | 13.0 | 14.40 | 15.90 | 1 | 21.5 | 28.0 | 1 | X |
| SMA6L14A | BK | 14.0 | 15.60 | 17.20 | 1 | 23.2 | 25.9 | 1 | X |
| SMA6L15A | BM | 15.0 | 16.70 | 18.50 | 1 | 24.4 | 24.6 | 1 | X |
| SMA6L16A | BP | 16.0 | 17.80 | 19.70 | 1 | 26.0 | 23.1 | 1 | X |
| SMA6L17A | BR | 17.0 | 18.90 | 20.90 | 1 | 27.6 | 21.8 | 1 | X |
| SMA6L18A | BT | 18.0 | 20.00 | 22.10 | 1 | 29.2 | 20.6 | 1 | X |
| SMA6L20A | BV | 20.0 | 22.20 | 24.50 | 1 | 32.4 | 18.6 | 1 | X |
| SMA6L22A | BX | 22.0 | 24.40 | 26.90 | 1 | 35.5 | 16.9 | 1 | X |
| SMA6L24A | BZ | 24.0 | 26.70 | 29.50 | 1 | 38.9 | 15.5 | 1 | X |
| SMA6L26A | CE | 26.0 | 28.90 | 31.90 | 1 | 42.1 | 14.3 | 1 | X |
| SMA6L28A | CG | 28.0 | 31.10 | 34.40 | 1 | 45.4 | 13.3 | 1 | X |
| SMA6L30A | CK | 30.0 | 33.30 | 36.80 | 1 | 48.4 | 12.4 | 1 | X |
| SMA6L33A | CM | 33.0 | 36.70 | 40.60 | 1 | 53.3 | 11.3 | 1 | X |
| SMA6L36A | CP | 36.0 | 40.00 | 44.20 | 1 | 58.1 | 10.4 | 1 | X |
| SMA6L40A | CR | 40.0 | 44.40 | 49.10 | 1 | 64.5 | 9.3 | 1 | X |
| SMA6L43A | CT | 43.0 | 47.80 | 52.80 | 1 | 69.4 | 8.7 | 1 | X |
| SMA6L45A | CV | 45.0 | 50.00 | 55.30 | 1 | 72.7 | 8.3 | 1 | X |
| SMA6L48A | CX | 48.0 | 53.30 | 58.90 | 1 | 77.4 | 7.8 | 1 | X |
| SMA6L51A | CZ | 51.0 | 56.70 | 62.70 | 1 | 82.4 | 7.3 | 1 | X |
| SMA6L54A | RE | 54.0 | 60.00 | 66.30 | 1 | 87.1 | 6.9 | 1 | X |
| SMA6L58A | RG | 58.0 | 64.40 | 71.20 | 1 | 93.6 | 6.5 | 1 | X |
| SMA6L60A | RK | 60.0 | 66.70 | 73.70 | 1 | 96.8 | 6.2 | 1 | X |
| SMA6L64A | RM | 64.0 | 71.10 | 78.60 | 1 | 103.0 | 5.9 | 1 | X |
| SMA6L70A | RP | 70.0 | 77.80 | 86.00 | 1 | 113.0 | 5.3 | 1 | X |
| SMA6L75A | RR | 75.0 | 83.30 | 92.10 | 1 | 121.0 | 5.0 | 1 | X |
| SMA6L78A | RT | 78.0 | 86.70 | 95.80 | 1 | 126.0 | 4.8 | 1 | X |
| SMA6L85A | RV | 85.0 | 94.40 | 104.00 | 1 | 137.0 | 4.4 | 1 | X |

I-V Curve Characteristics



P_{PPM} Peak Pulse Power Dissipation – Max power dissipation

V_R Stand-off Voltage – Maximum voltage that can be applied to the TVS without operation

V_{BR} Breakdown Voltage – Maximum voltage that flows through the TVS at a specified test current (I_T)

V_C Clamping Voltage – Peak voltage measured across the TVS at a specified I_{ppm} (peak impulse current)

I_R Reverse Leakage Current – Current measured at V_R

V_F Forward Voltage Drop for Uni-directional

Ratings and Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

Figure 1 - TVS Transients Clamping Waveform

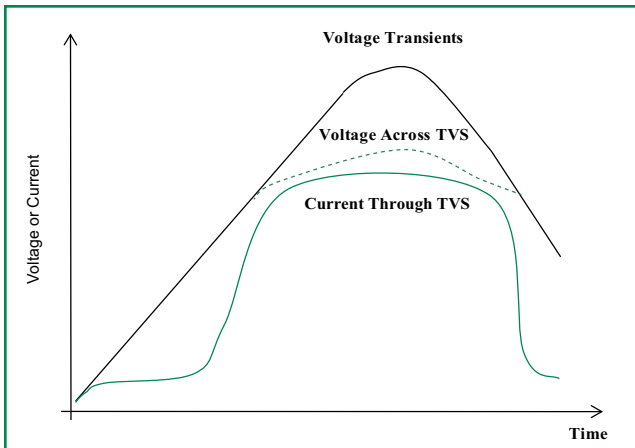
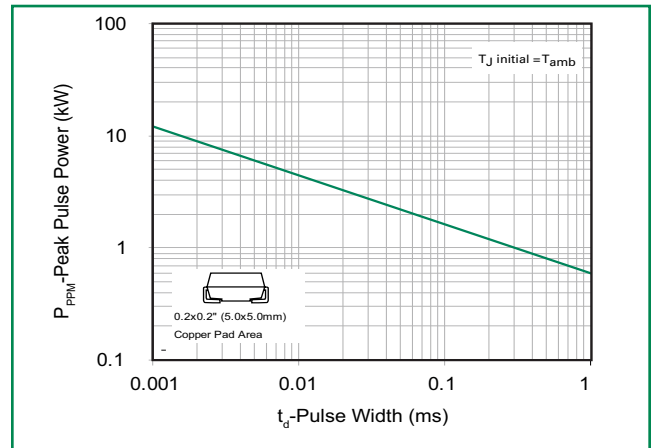


Figure 2 - Peak Pulse Power Rating Curve



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Ratings and Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted) (Continued)

Figure 3 - Peak Pulse Power Derating Curve

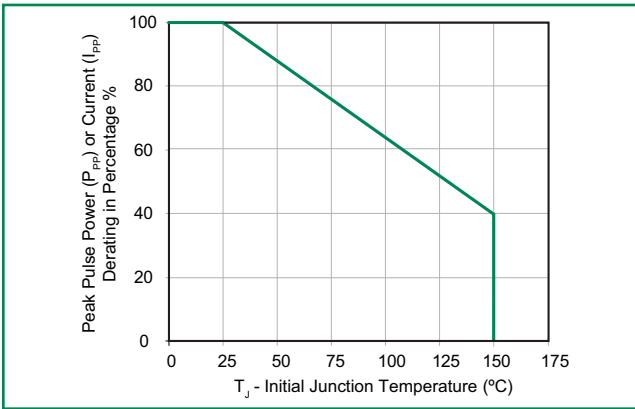


Figure 4 - Pulse Waveform

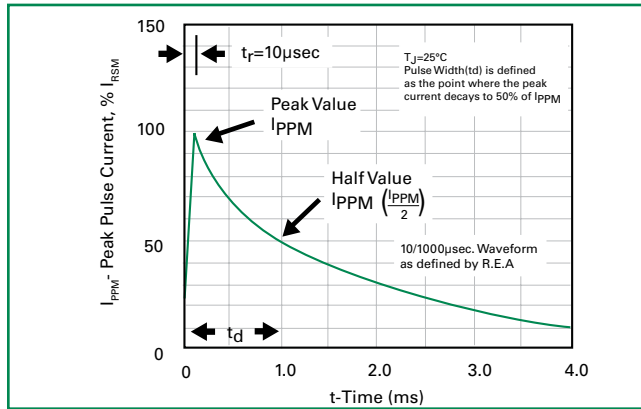


Figure 5 - Typical Junction Capacitance

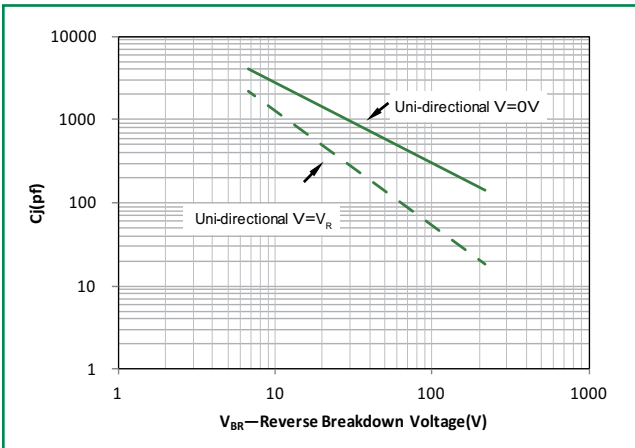


Figure 6 - Maximum Non-Repetitive Forward Surge Current Uni-Directional Only

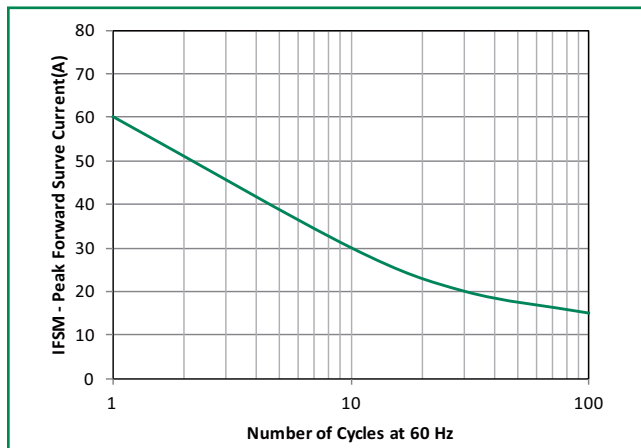
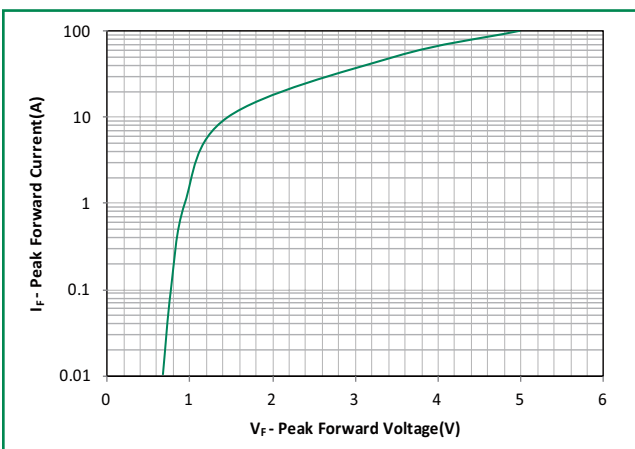
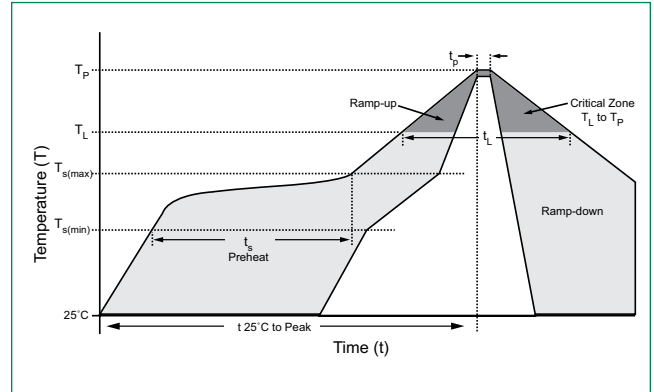


Figure 7 - Peak Forward Voltage Drop vs Peak Forward Current (typical values)



Soldering Parameters

| | | |
|--|------------------------------------|-------------------------|
| Reflow Condition | | Lead-free assembly |
| Pre Heat | - Temperature Min ($T_{s(min)}$) | 150°C |
| | - Temperature Max ($T_{s(max)}$) | 200°C |
| | - Time (min to max) (t_s) | 60 – 180 secs |
| Average ramp up rate (Liquidus Temp (T_A) to peak) | | 3°C/second max |
| $T_{s(max)}$ to T_A - Ramp-up Rate | | 3°C/second max |
| Reflow | - Temperature (T_A) (Liquidus) | 217°C |
| | - Time (min to max) (t_s) | 60 – 150 seconds |
| Peak Temperature (T_p) | | 260 ^{+0/-5} °C |
| Time within 5°C of actual peak Temperature (t_p) | | 20 – 40 seconds |
| Ramp-down Rate | | 6°C/second max |
| Time 25°C to peak Temperature (T_p) | | 8 minutes Max. |
| Do not exceed | | 260°C |



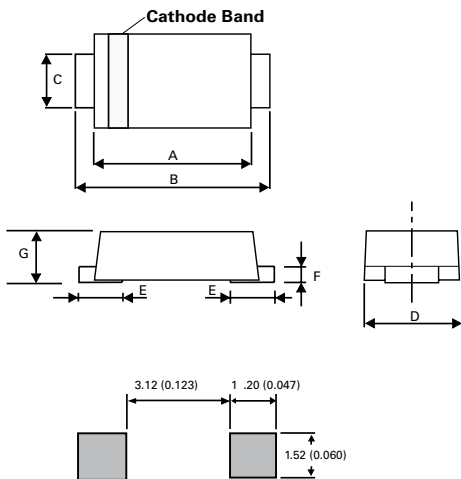
Physical Specifications

| | |
|-----------------|--|
| Weight | 0.002 ounce, 0.061 gram |
| Case | JEDEC DO-221AC Molded Plastic over glass passivated junction |
| Polarity | Color band denotes cathode except Bipolar |
| Terminal | Matte Tin-plated leads, Solderable per JESD22-B102 |

Environmental Specifications

| | |
|----------------------------|--------------------------|
| High Temp. Storage | JESD22-A103 |
| HTRB | JESD22-A108 |
| Temperature Cycling | JESD22-A104 |
| MSL | JEDEC-J-STD-020, Level 1 |
| H3TRB | JESD22-A101 |
| RSH | JESD22-A111 |

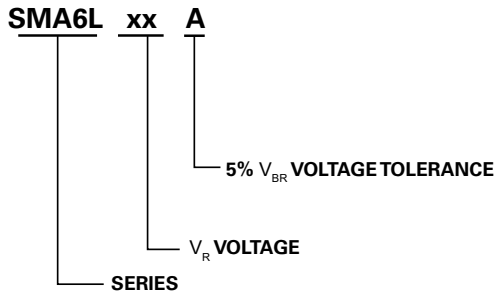
Dimensions



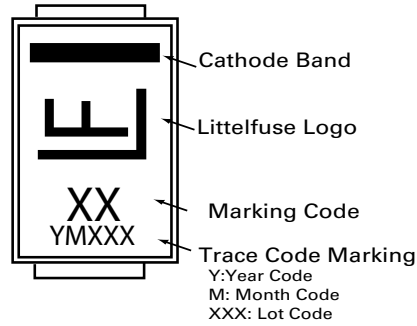
Mounting Pad Layout

| Dimensions | Inches | | Millimeters | |
|------------|--------|-------|-------------|-------|
| | Min | Max | Min | Max |
| A | 0.156 | 0.181 | 3.950 | 4.600 |
| B | 0.189 | 0.220 | 4.800 | 5.600 |
| C | 0.049 | 0.069 | 1.250 | 1.750 |
| D | 0.088 | 0.116 | 2.250 | 2.950 |
| E | 0.030 | 0.059 | 0.750 | 1.500 |
| F | 0.005 | 0.010 | 0.125 | 0.250 |
| G | 0.035 | 0.043 | 0.900 | 1.100 |

Part Numbering System



Part Marking System



Packaging

| Part number | Component Package | Quantity | Packaging Option | Packaging Specification |
|-------------|-------------------|----------|----------------------------|-------------------------|
| SMA6LxxA | DO-221AC | 3000 | Tape & Reel – 12mm/7" tape | EIA RS-481 |

Tape and Reel Specification

